SiDR5102EP

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Vishay Siliconix

N-Channel 100 V (D-S) 175 °C MOSFET



Top View

Bottom View

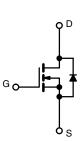
PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0041			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0056			
Q _g typ. (nC)	25.1			
I _D (A)	126			
Configuration	Single			

FEATURES

- TrenchFET[®] Gen V power MOSFET
- Very low R_{DS} Q_g figure-of-merit (FOM)
- Tuned for the lowest R_{DS} Q_{oss} FOM
- 100 % R_{q} and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- Primary side switch
- DC/DC converters
- OR-ing and hot swap switch
- Power supplies
- Motor drive control
- Battery management



N-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK SO-8DC		
Lead (Pb)-free and halogen-free	SIDR5102EP-T1-RE3		

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	V	
Gate-source voltage		V _{GS}	± 20		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		126		
	T _C = 70 °C		105.5		
	T _A = 25 °C	I _D	28.2 ^{a, b}		
	T _A = 70 °C		23.5 ^{a, b}		
Pulsed drain current (t = 100 µs)		I _{DM}	300	— A	
Continuous source-drain diode current	T _C = 25 °C		136		
	T _A = 25 °C	I _S	6.8 ^{a, b}		
Single pulse avalanche current	ulse avalanche current	I _{AS}	45		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	101	mJ	
Maximum power dissipation	T _C = 25 °C		150		
	T _C = 70 °C		105		
	T _A = 25 °C	P _D	7.5 ^{a, b}	W	
	T _A = 70 °C		5.25 ^{a, b}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	*0	
Soldering recommendations (peak temperature) d, e		Ŭ	260	°C	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

- c. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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(Pb)

RoHS COMPLIANT HALOGEN FREE



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THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R _{thJA}	15	20		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.8	1	°C/W	
Maximum junction-to-case (source)	Steady state	R _{thJC}	1.1	1.4		

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 54 °C/W

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	- I			•	•	<u> </u>
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 1 mA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	58	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.0	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
Zero gate voltage drain current		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
	IDSS	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	15	μA
Drain-source on-state resistance ^a		V _{GS} = 10 V, I _D = 20 A	-	0.0034	0.0041	Ω
	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 20 A	-	0.0041	0.0056	
Forward transconductance ^a	g fs	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	57	-	S
Dynamic ^b						•
Input capacitance	C _{iss}		-	2850	-	pF
Output capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	-	1050	-	
Reverse transfer capacitance	C _{rss}		-	9.2	-	
		V _{DS} = 50 V, V _{GS} = 10 V, I _D = 20 A V _{DS} = 50 V, V _{GS} = 7.5 V, I _D = 20 A	-	33.7	51	
Total gate charge	Qg		-	25.1	38	nC
Gate-source charge	Q _{gs}		-	15.7	-	
Gate-drain charge	Q _{gd}		-	1.7	-	
Output charge	Q _{oss}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	106.5	-	
Gate resistance	R _q	f = 1 MHz	0.5	1.15	2	Ω
Turn-on delay time	t _{d(on)}		-	15	30	-
Rise time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 2.5 \Omega, \text{ I}_{\text{D}} \cong 20 \text{ A},$	-	10	20	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	26	52	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	19	38	ns
Rise time	tr	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 2.5 \Omega, \text{ I}_{\text{D}} \cong 20 \text{ A},$	-	14	28	-
Turn-off delay time	t _{d(off)}	$V_{GEN} = 7.5 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	25	50	
Fall time	t _f		-	12	24	
Drain-Source Body Diode Characterist	ics				•	<u> </u>
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	136	
Pulse diode forward current	I _{SM}		-	-	300	A
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.74	1.1	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C	-	53	106	ns
Body diode reverse recovery charge	Q _{rr}		-	67	134	nC
Reverse recovery fall time	ta		-	25	-	
Reverse recovery rise time	t _b		-	28	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

S22-0031-Rev. A, 17-Jan-2022

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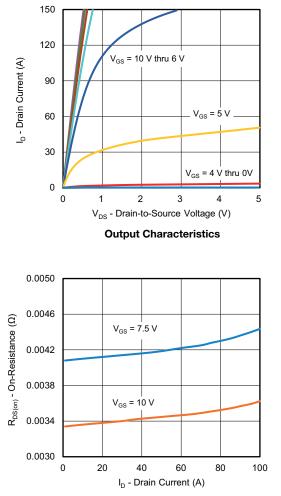
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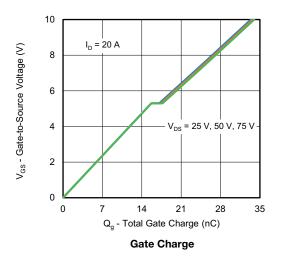
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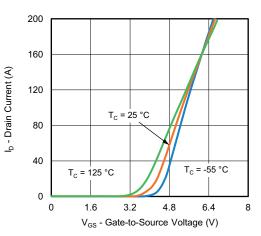
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

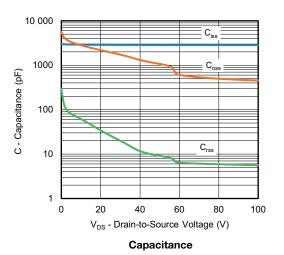


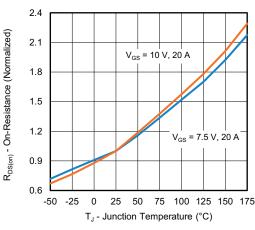
On-Resistance vs. Drain Current and Gate Voltage





Transfer Characteristics





On-Resistance vs. Junction Temperature

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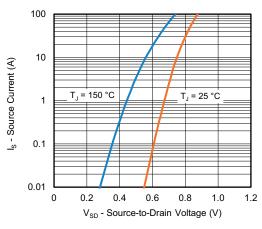
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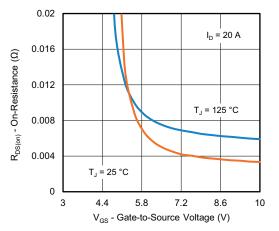


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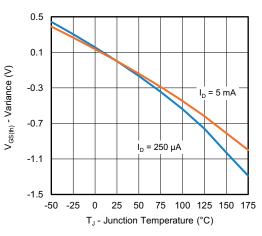
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



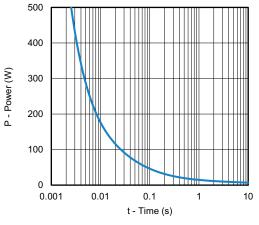
Source-Drain Diode Forward Voltage



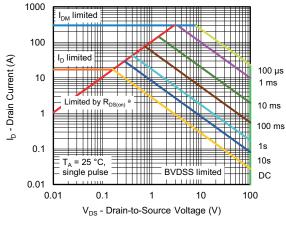
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

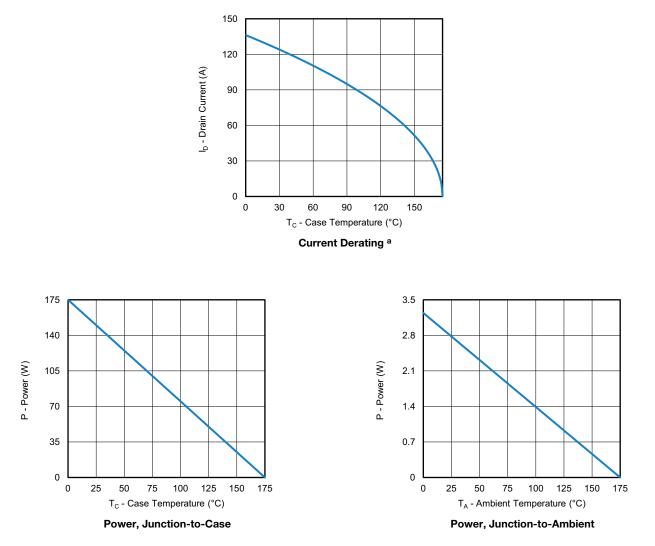
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

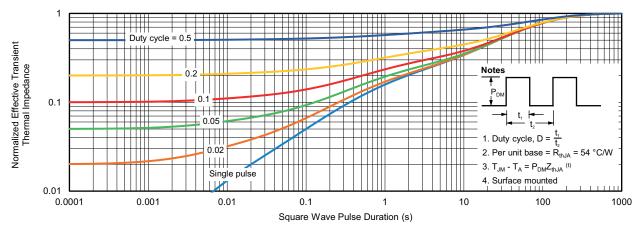
a. The power dissipation P_D is based on T_J max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



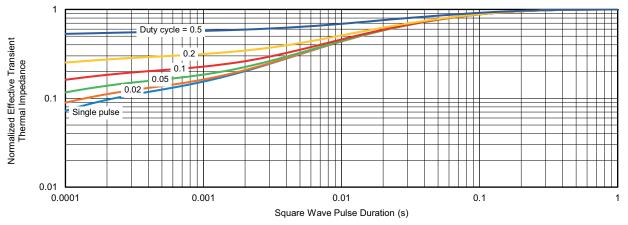
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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